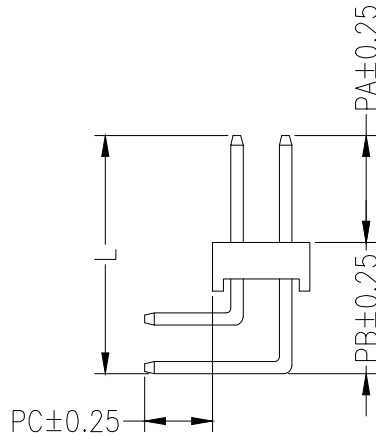
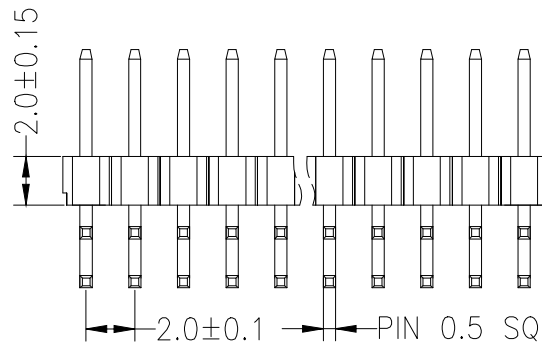
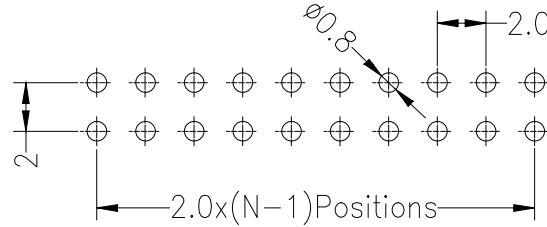
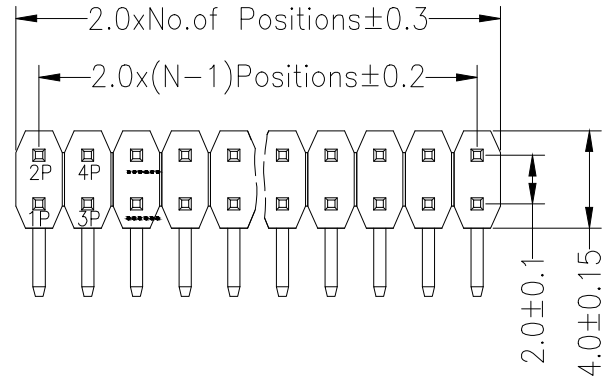


Recommended P.C.B Layout(Top Side)  
( PCB BOARD TOLERANCE±0.05 )



SPECIFICATIONS  
Rated Current:1.5AMP  
Contact Resistance:20mΩ Max  
Withstand Voltage:500V AC/DC  
Insulation Resistance:1000MΩ Min  
Operation Temperature:-40°c to +105°c

Contact Material:Brass  
Contact Plating:Au or Sn Over Ni  
Insulator Material:Polyester(UL94V-0)  
Standard: PA6T  
Max.Processing Temp: 230°C for 30-60 seconds  
(260°C for 5 seconds)

Dimension antitheses list				
ITEM	PA	PB	PC	L
Standard	4.00	5.40	2.80	9.40
Alternate				

Ordering Information

XDZ 200 - \* - N - W - \* - \*\*

No. of Rows  
1=Single Row  
2=Dual Row

No. of Pins  
02-40 Pin

Type  
Z=直针  
W=弯针  
S=插簧  
WS=带插

Length  
毫米

Contact Plating  
G0:Gold Flash  
G1:0.8u' Gold  
G2:3u' Gold  
G3:5u' Gold  
G4:10u' Gold  
G5:15u' Gold  
G6:30u' Gold  
S0:Gold Flash/Tin  
S1:1m

GENERAL TOLERANCE			制图 DRAWING		深圳讯答科技有限公司 ShenzhenXundaTechnology Co.,Ltd				
			DIM	TOL	审核 CHECK	产品名称 TITLE	2.00 双排 正弯 排针 (塑高2.0)	版本 REV.	A
			X.X	±0.30	批准 APPROVAL	产品料号 PART NO.	XDZ200-2-N-W-2.0-G1	单位 UNITS	mm
			X.XX	±0.20	比例 SCALE			页次 SHEET	1/1
			X.XXX	±0.10	投影 Projection	材料 MATERIAL			
1	初版发行		Angle	±3.0°					
序号 No.	变更内容 MODIFY CONTENT	日期 MODIFY DATE							